

FDMS3500 N-Channel Power Trench[®] MOSFET

MOSFET Maximum Ratings T_A = 25°C unless otherwise noted

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Symbol	Parameter			Ratings	Units	
V _{DS}	Drain to Source Voltage			75	V	
V _{GS}	Gate to Source Voltage			±20	V	
ID	Drain Current -Continuous (Package limited)	T _C = 25°C		49		
	-Continuous (Silicon limited)	T _C = 25°C		57	Ξ.	
	-Continuous	T _A = 25°C	(Note 1a)	9.2	— A	
	-Pulsed			100		
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	384	mJ	
P _D	Power Dissipation	T _C = 25°C		96	W	
	Power Dissipation	T _A = 25°C	(Note 1a)	2.5		
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C	

Thermal Characteristics

$R_{\theta JC}$	Thermal Resistance, Junction to Case	1.3	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (Note 1a	l) 50	C/VV

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS3500	FDMS3500	Power 56	13"	12mm	3000 units

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cteristics Drain to Source Breakdown Voltage Breakdown Voltage Temperature Coefficient Zero Gate Voltage Drain Current Gate to Source Leakage Current cteristics	$I_{D} = 250 \mu A, V_{GS} = 0V$ $I_{D} = 250 \mu A, referenced to 25^{\circ}C$ $V_{GS} = 0V, V_{DS} = 60V,$ $V_{GS} = \pm 20V, V_{DS} = 0V$	75	71		
Breakdown Voltage Temperature Coefficient Zero Gate Voltage Drain Current Gate to Source Leakage Current	$I_D = 250\mu$ A, referenced to 25°C $V_{GS} = 0$ V, $V_{DS} = 60$ V,	75	71		
Breakdown Voltage Temperature Coefficient Zero Gate Voltage Drain Current Gate to Source Leakage Current	$I_D = 250\mu$ A, referenced to 25°C $V_{GS} = 0$ V, $V_{DS} = 60$ V,		71		V
Gate to Source Leakage Current					mV/°C
-				1	μA
teristics				±100	nA
Gate to Source Threshold Voltage	V _{GS} = V _{DS} , I _D = 250μA	1.0	1.8	3.0	V
Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \mu A$, referenced to 25°C		-6.8		mV/°C
	V _{GS} = 10V, I _D = 11.5A		11.1	14.5	1
Static Drain to Source On Resistance	V _{GS} = 4.5V, I _D = 10A		12.8	16.3	mΩ
	$V_{GS} = 10V, I_D = 11.5A, T_J = 125^{\circ}C$		17.6	23.0	1
Forward Transconductance	V _{DD} = 5V, I _D = 11.5A		56		S
Characteristics					
			3580	4765	pF
	$-V_{DS} = 40V, V_{GS} = 0V,$		225	300	pF
Reverse Transfer Capacitance	t = 1MHz		120	175	pF
Gate Resistance	f = 1MHz		1.2		Ω
Characteristics					1
Turn-On Delay Time			16	29	ns
Rise Time	$V_{DD} = 40V, I_D = 11.5A,$		-	-	ns
	$V_{GS} = 10V, R_{GEN} = 6\Omega$				ns
			-		ns
				-	nC
	$V_{GS} = 0V \text{ to } 5V$ $V_{DD} = 40V,$		-	48	nC
-	I _D = 11.5A				nC
			11.6		nC
Gate to Drain "Miller" Charge					
rce Diode Characteristics					_
-	V _{GS} = 0V, I _S = 11.5A (Note 2) V _{GS} = 0V, I _S = 2.1A (Note 2)		0.8	1.3	v
rce Diode Characteristics	$\frac{V_{GS} = 0V, I_S = 11.5A}{V_{GS} = 0V, I_S = 2.1A}$ (Note 2) (Note 2) (Note 2) (Note 2) (Note 2)			1.3 1.2 60	V ns
	Temperature Coefficient Static Drain to Source On Resistance Forward Transconductance Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance Characteristics Turn-On Delay Time	$\begin{tabular}{ c c c c } \hline Temperature Coefficient & $I_D = 250 \mu A, referenced to $25°C \\ \hline Temperature Coefficient & $V_{GS} = 10V, \ I_D = 11.5A \\ \hline V_{GS} = 10V, \ I_D = 11.5A \\ \hline V_{GS} = 10V, \ I_D = 11.5A, \ T_J = 125°C \\ \hline Forward Transconductance & $V_{DD} = 5V, \ I_D = 11.5A \\ \hline \end{tabular}$	Temperature CoefficientID 250μ A, referenced to 25° CStatic Drain to Source On Resistance $V_{GS} = 10V, I_D = 11.5A$ $V_{GS} = 10V, I_D = 10A$ VGS $= 10V, I_D = 10A$ $V_{GS} = 10V, I_D = 11.5A, T_J = 125^{\circ}$ CForward Transconductance $V_{DD} = 5V, I_D = 11.5A$ $V_{DD} = 5V, I_D = 11.5A$ Input Capacitance $V_{DS} = 40V, V_{GS} = 0V, f = 10Hz$ $P_{DS} = 40V, V_{GS} = 0V, f = 10Hz$ Characteristics $f = 1MHz$ $P_{DS} = 40V, V_{GS} = 0V, f = 10Hz$ Gate Resistance $f = 1MHz$ $P_{DD} = 11.5A, V_{CS} = 0V, f = 10Hz$ Turn-On Delay Time $V_{DD} = 40V, I_D = 11.5A, V_{CS} = 10V, R_{GEN} = 6\Omega$ Fall Time $V_{GS} = 0V \text{ to } 10V, V_{DD} = 40V, I_D = $	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	$\begin{array}{c c c c c c c c c c c c c c c c c c c $

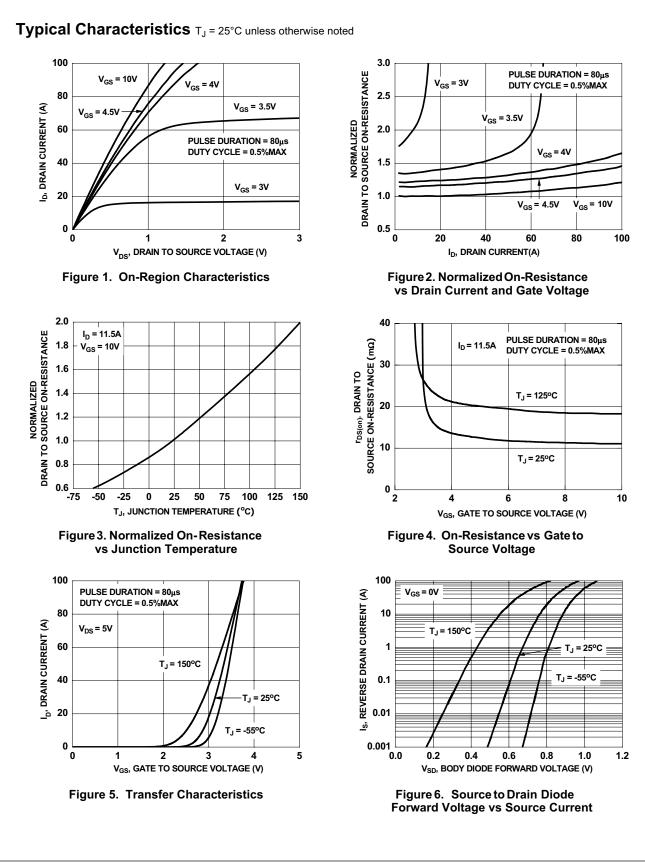
2. Pulse Test: Pulse Width < 300 μ s, Duty cycle < 2.0%.

3. Starting T_J = 25°C, L = 3mH, I_{AS} = 16A, V_{DD} = 75V, V_{GS} = 10V

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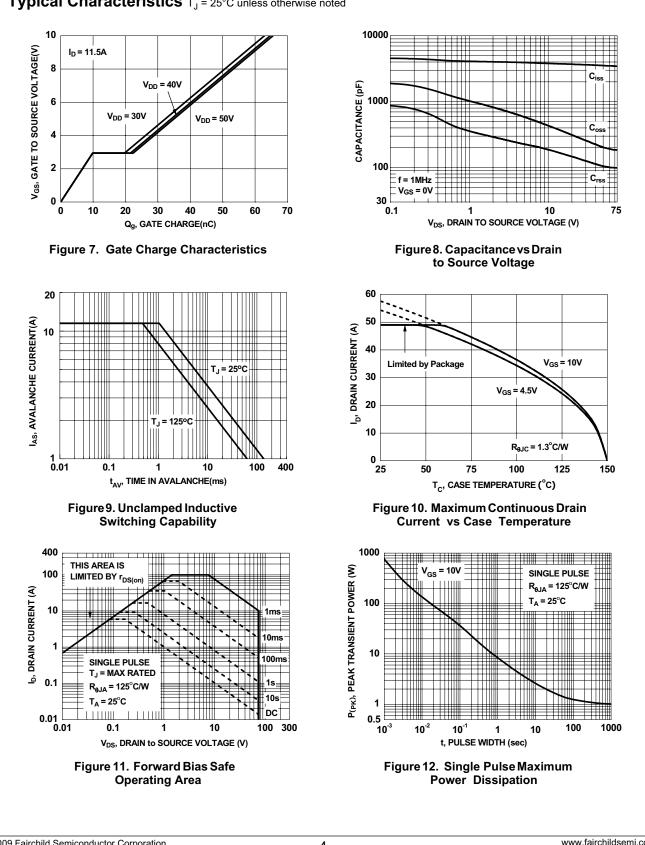
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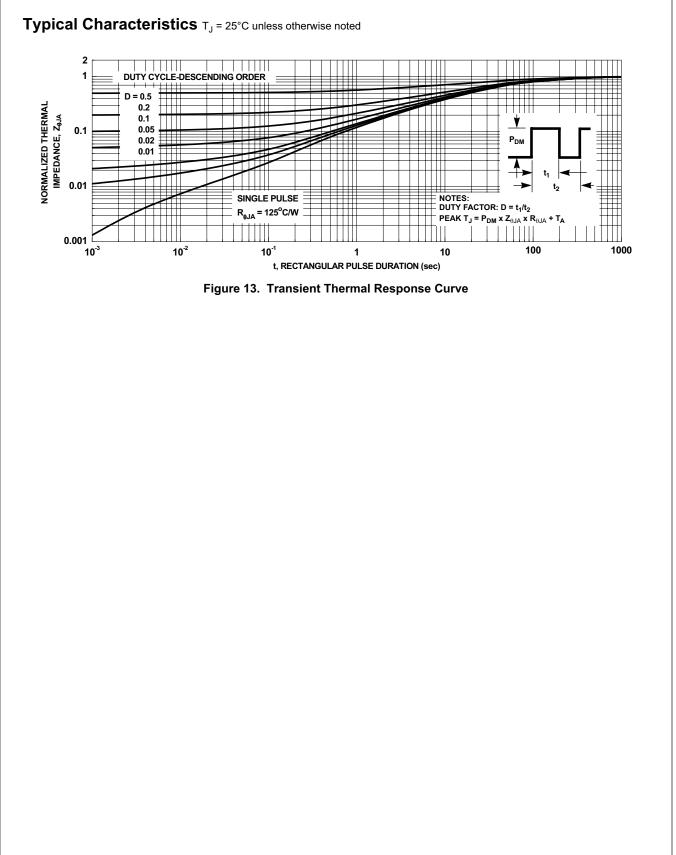


Typical Characteristics $T_J = 25^{\circ}C$ unless otherwise noted

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